

## Tentative

## CM600DY-12NF

Pre.	S.Uchida	Rev	B	H.Hanada.
Apr.	M.Tabata 13-Sep-'02			(M.Tabata 21-Feb-'03)

HIGH POWER SWITCHING USE

Notice : This is not a final specification. Some parametric limits are subject to change.

CM600DY-12NF

- $I_c$  ..... 600A
- $V_{CES}$  ..... 600V
- Insulated Type
- 2-elements in a pack

## APPLICATION

General purpose inverters & Servo controls, etc

ABSOLUTE MAXIMUM RATINGS ( $T_j = 25\text{ }^\circ\text{C}$ )

Symbol	Item	Conditions	Ratings	Units
$V_{CES}$	Collector-emitter voltage	G-E Short	600	V
$V_{GES}$	Gate-emitter voltage	C-E Short	$\pm 20$	V
$I_c$	Collector current	DC, $T_c = 89\text{ }^\circ\text{C}^{*3}$	600	A
$I_{CM}$		Pulse (2)	1200	
$I_E$ (1)	Emitter current		600	A
$I_{EM}$ (1)		Pulse (2)	1200	
$P_c$ (3)	Maximum collector dissipation	$T_c = 25\text{ }^\circ\text{C}$	1130	W
$T_j$	Junction temperature		$-40\sim+150$	$^\circ\text{C}$
$T_{stg}$	Storage temperature		$-40\sim+125$	$^\circ\text{C}$
Viso	Isolation voltage	Main terminal to base plate, AC 1 min.	2500	V
—	Torque strength	Main terminal M6	3.5 ~ 4.5	N·m
—	Torque strength	Mounting holes M6	3.5 ~ 4.5	N·m
—	Weight	Typical value	580	g

ELECTRICAL CHARACTERISTICS ( $T_j = 25\text{ }^\circ\text{C}$ )

Symbol	Item	Conditions	Min.	Typ.	Max.	Units		
$I_{CES}$	Collector cutoff current	$V_{CE}=V_{CES}, V_{GE}=0V$	—	—	1	mA		
$V_{GE(th)}$	Gate-emitter threshold voltage	$I_C=60mA, V_{CE}=10V$	5	6	7.5	V	A	
$I_{GES}$	Gate leakage current	$V_{GE}=V_{GES}, V_{CE}=0V$	—	—	0.5	$\mu A$		
$V_{CE(sat)}$	Collector to emitter saturation voltage	$T_j = 25\text{ }^\circ\text{C}$	—	1.7	2.2	V		
		$T_j = 125\text{ }^\circ\text{C}$						$I_C = 600A$
$C_{ies}$	Input capacitance	$V_{CE}=10V$	—	—	90	nF		
$C_{oes}$	Output capacitance	$V_{GE}=0V$	—	—	11			
$C_{res}$	Reverse transfer capacitance		—	—	3.6			A
$Q_G$	Total gate charge	$V_{CC}=300V, I_C=600A, V_{GE}=15V$	—	2400	—	nC		
$t_{d(on)}$	Turn-on delay time	$V_{CC}=300V, I_C=600A$	—	—	500	ns	A	
$t_r$	Turn-on rise time	$V_{GE1}=V_{GE2}=15V$	—	—	300			
$t_{d(off)}$	Turn-off delay time	$R_G=4.2\Omega$ , Inductive load	—	—	750		A	
$t_f$	Turn-off fall time	switching operation	—	—	300			
$t_{rr}$ ①	Reverse recovery time	$I_E=600A$	—	—	250	ns		
$Q_{rr}$ ①	Reverse recovery charge		—	8.7	—	$\mu C$	A	
$V_{EC}$ ①	Emitter-collector voltage	$I_E=600A, V_{GE}=0V$	—	—	2.6	V		
$R_{th(j-c)Q}$	Thermal resistance	IGBT part (1/2 module) *1	—	—	0.11	$^\circ\text{C/W}$	A	
$R_{th(j-c)R}$		FWDi part(1/2 module) *1	—	—	0.18			
$R_{th(c-f)}$	Contact thermal resistance	Case to fin, Thermal compound Applied (1/2module) *2	—	0.02	—			
$R_{th(j-c'')Q}$	Thermal resistance	IGBT part (1/2 module) *3	—	—	0.046			B
$R_G$	External gate resistance		1.0	—	10	$\Omega$	A	

\*1:  $T_c$  measured point is shown in page OUTLINE DRAWING.

\*2: Typical value is measured by using Shin-etsu Silicone "G-746".

\*3:  $T_c'$  measured point is just under the chips.

If you use this value,  $R_{th(f-a)}$  should be measured just under the chips..

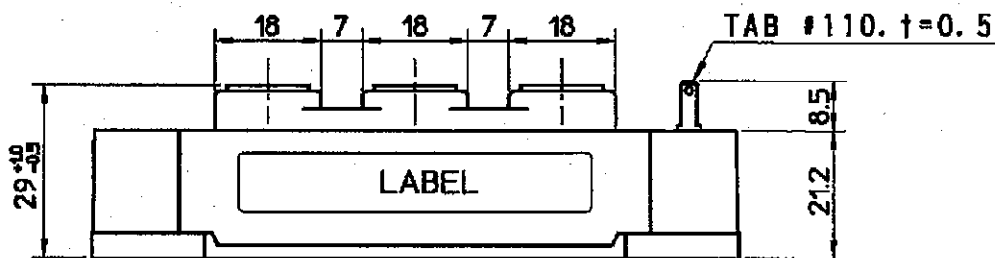
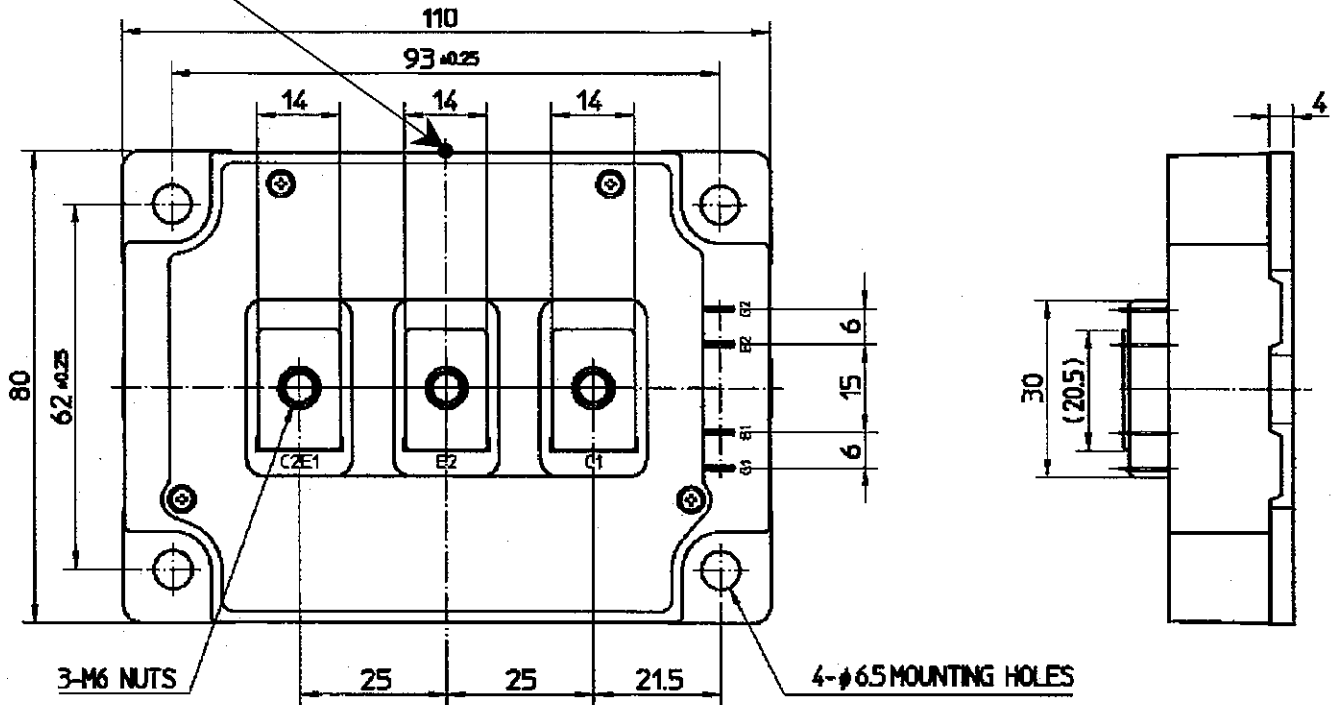
- ①  $I_E, V_{EC}, t_{rr}, Q_{rr}$  &  $di/dt$  represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
- ② Pulse width and repetition rate should be such that the device junction temp. ( $T_j$ ) dose not exceed  $T_{jmax}$  rating.
- ③ Junction temperature ( $T_j$ ) should not increase beyond  $150^\circ\text{C}$ .
- ④ Pulse width and repetition rate should be such as to cause neglible temperature rise.

OUTLINE DRAWING

Dimensions in mm

A

Tc measured point (Base plate)



CIRCUIT DIAGRAM

